

Attorney Docket # 4956-4

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Xiaohui WANG et al.

Serial No.: 09/939,916

Filed: August 27, 2001

For: A Material for Making Hyper Frequency Multi-Layer Chip Inductors with High Performance and Low Sintering Temperature and a Process for Preparing the Material

Examiner: Kopec, Mark T

Group Art: 1751

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

February 5, 2004

(Date of Deposit)

Yunling Ren

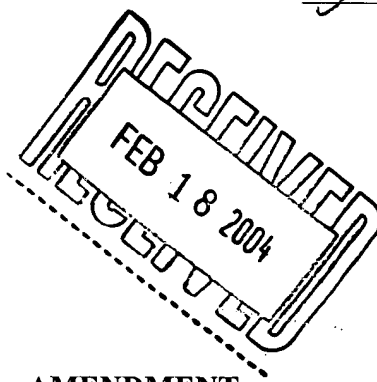
Name of applicant, assignee or Registered Representative

Signature

February 5, 2004

Date of Signature

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Commissioner for Patents  
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AMENDMENT

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SIR:

In response to the Office Action dated November 14, 2004, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.